



Product Change Notification

Change Notification #: 117816 - 00
Change Title: Select Intel® SSD 660p Series SKUs,
PCN 117816-00, Product Discontinuance,
End of Life
Date of Publication: October 8, 2020

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	October 8, 2020
Last Product Discontinuance Shipment Date:	December 31, 2020

Description of Change to the Customer:

Intel is announcing the End of Life timeline for select Intel® SSD 660p Series SKUs.

The Intel® SSD 660p Series SKUs listed on the "Products Affected/Intel Ordering Codes" table below will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date."

Please refer to the Product Affected/Intel Ordering Codes table with recommended replacement SKUs.

Effective "Last Ship Date" Intel will stop shipping select Intel® SSD 660p Series hardware.

Customer Impact of Change and Recommended Action:

This Product Discontinuance Notification is published as a follow up of PCN117742-00.

Please determine your remaining demand for the SKUs listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above.

The Intel® SSD 660p Series SKUs listed on the "Products Affected/Intel Ordering Codes" table below that do not have recommended replacement SKUs will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date."

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

* Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Recommended Replacement Product Code	Recommended Replacement MM#
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW512G801	976802	SSDPEKNW512G8AU	999M5F
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW010T801	976803	SSDPEKNW010T8AU	999M5H
Intel® SSD 660p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW256G801	980906	N/A	N/A
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 10 Pack	SSDPEKNW512G810	981634	N/A	N/A
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 100 Pack	SSDPEKNW512G8	999CG3	SSDPEKNW512G8AS	999M0M
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 100 Pack	SSDPEKNW010T8	999CG4	SSDPEKNW010T8AS	999M0V

PCN Revision History:

Date of Revision:

October 8, 2020

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

117816 - 00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2020. Other names and brands may be claimed as the property of others.

3D XPoint, ACEX, Altera, APEX, AnyWAN, Arria, Avalon, Axxia, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, CONVERGATE, Cyclone, Docea, eASIC, easicopy, Enpirion, Flexpipe, Hyperflex, Intel, the Intel logo, Intel Adaptix, Intel Agilex, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Falcon, Intel Inside, the Intel Inside logo, Intel Nervana, Intel Optane, Intel RealSense, Intel Shooting Star, Intel Sirius, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Iris, Itanium, MAX, Movidius, Myriad, neon, Nios, OpenVINO, the OpenVINO logo, Pentium, Puma, Quark, Quartus, SICOFL, Simics, SMARTi, SoftSilicon, Sound Mark, StarPro, Stratix, the Stratix logo, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcede, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS* Ready mark under license from Palm, Inc.

OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.